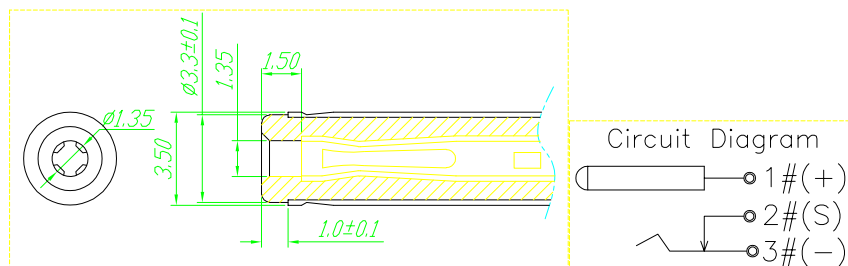
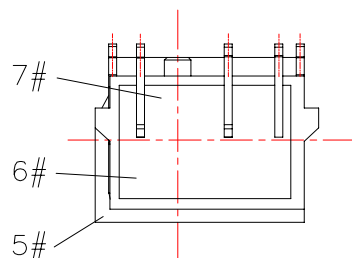
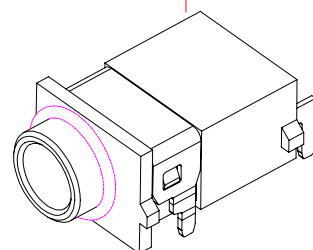
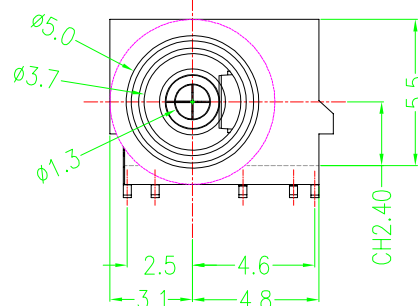
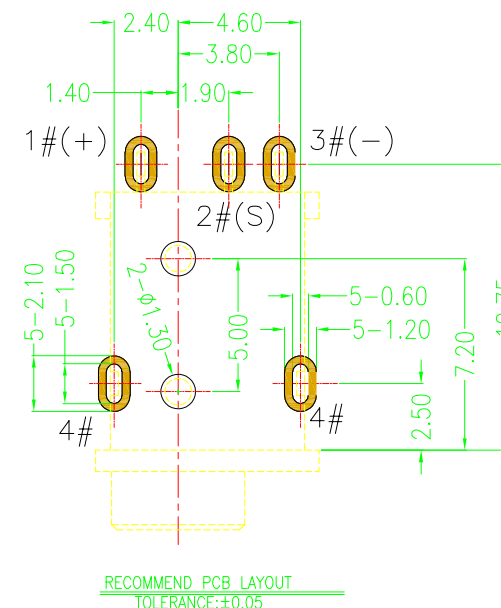
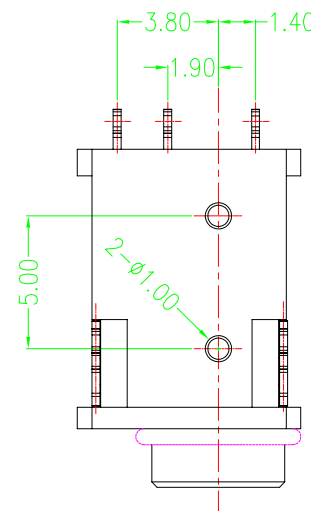
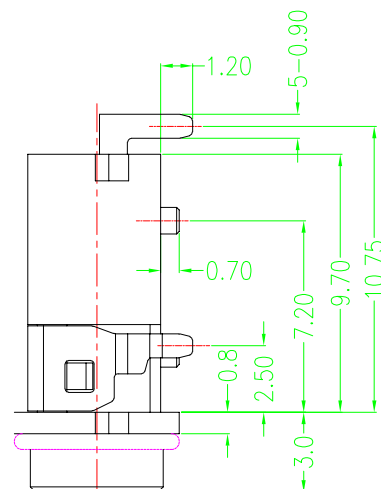
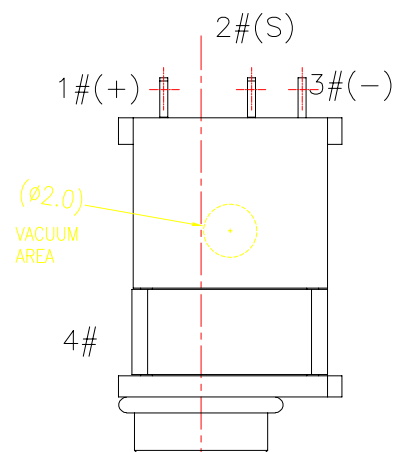


ZONE	SYMBOL	REVISION	APPROVAL	DATE
A		LSJ	WJZ	2021.06.16



Notes:

- 1.Current Rating: 24V& 3A max.
- 2.Contact Resistance: 50mOhms Max.(initial)
- 3.Insulation Resistance: 100M Ohms Min./500V DC
- 4.Dielectric Withstanding Voltage: 500V AC/1Minute
- 5.Mating Force: 35N Max, Withdrawal Force: 3N Min.
- 6.Durability: 5,000 Cycles
- 7.Operating Temperature: -25°C to+85°C



3D VIEW

7	BOND	1	EPOXY;BLACK	
6	BACK COVER	1	HIGH TEMPERATURE; COLOR BLACK	
5	HOUSING	1	HIGH TEMPERATURE; COLOR BLACK	
4	TERMINAL 4#	2	COPPER ALLOY; NICKEL UNDER PLATING OVERALL;GOLD FLASH PLATING ON SOLDER AREA ;GOLD FLASH PLATING ON CONTACT AREA	
3	TERMINAL 3#	1	COPPER ALLOY; NICKEL UNDER PLATING OVERALL;GOLD FLASH PLATING ON SOLDER AREA ;GOLD FLASH PLATING ON CONTACT AREA	
2	TERMINAL 2#	1	COPPER ALLOY; NICKEL UNDER PLATING OVERALL;GOLD FLASH PLATING ON SOLDER AREA ;GOLD FLASH PLATING ON CONTACT AREA	
1	CENTER PIN	1	COPPER ALLOY; NICKEL UNDER PLATING OVERALL;GOLD FLASH PLATING ON SOLDER AREA ;GOLD FLASH PLATING ON CONTACT AREA	
ITEM	NAME	Q'TY	DESCRIPTION	NOTE

XG 东莞市溪榜电子有限公司
DONG GUAN XI BANG ELECTRONICS CO., LTD.

 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONICS CO., LTD.					DRAWING:	X B	DATE:	2021. 06. 16	SCALE	5: 1
					CHECK:	X S J	DATE:	2021. 06. 16	MATERIAL	*
PART NAME	DC POWER JACK	TOLERANCE UNLESS 0.0±0.20 0.00±0.10 OTHERWISE SPECIFIED: 0.000±0.05	UNIT: mm		APPROVAL:	W J Z	DATE:	2021. 06. 16	DWG. no.	A
PART NO.	XB-30002-05DBAP-A				DRAWING NO.	XB-30002-05DBAP-A			SHEET	1/1